

Meet The Customers Requirements With Premium Quality





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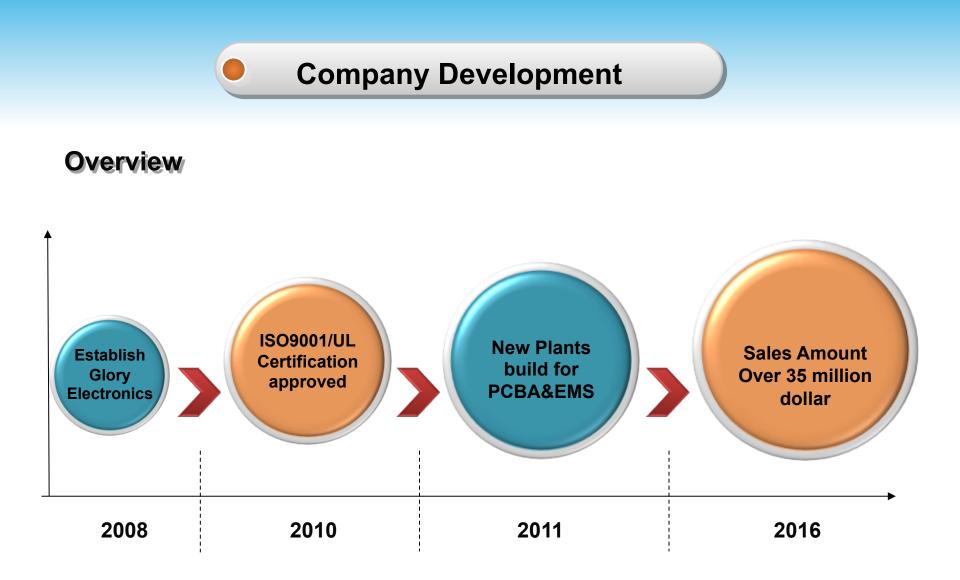
Company Brief Introduction

Basic Facts

Date Of Establishment	Building Area	Staff Member	Manufacture Capability
2008.10.01	20000 <i>m</i> ²	600	250,000 <i>m</i> ^₂

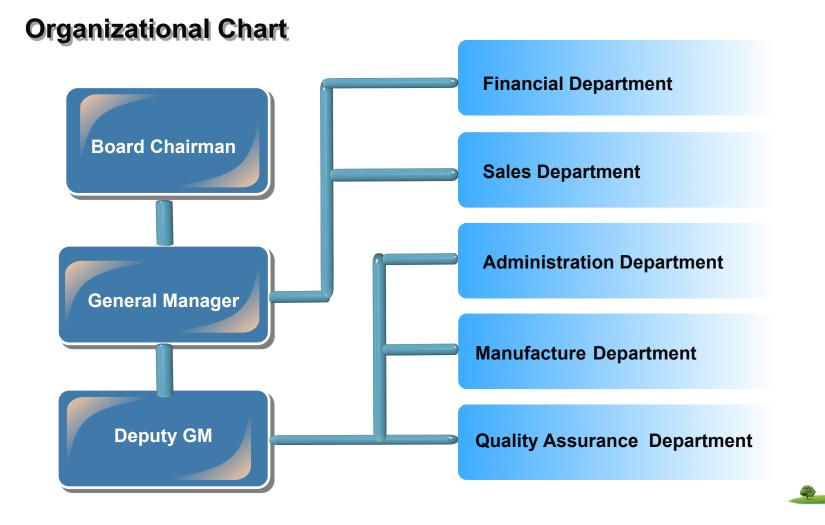
Main Products







Company Organization



Competitive Advantages

- Constituted by skilled & experienced specialist on PCB / Electronics Manufacturing;Engineering;Quality Assurance & Marketing.
- Best Service from our plant; Can get competitived price; Better quality; Actives Service.
- Just-in-time programs provide considerable savings and guarantee the delivery of speedy services;
- Design For Manufacturability (DFM) programs ensure optimum efficiency based on our professional engineer.
- One-Stop-Shopping solution for your total PCB & PCBA Demand.





Manufacture Capability

Layer Counts	248
Material	Polymide, FR-4, High TG FR-4, PTFE, Aluminum Base, Cu base. Rogers, etc
Maximum Size	700mm X 1000mm
Board Outline Tolerance	±0.10mm
Board Thickness	0.20mm8.00mm
Thickness Tolerance(t≥0.8mm)	±8%
Thickness Tolerance(t<0.8mm)	±10%
Insulation Layer Thickness	0.075mm5.00mm
M inimum Line	0.065mm
M inimum Space	0.065mm
Out Layer Copper Thickness	18um350um
Inner Layer Copper Thickness	17um175um
Drilling Hole (Mechanical)	0.15mm6.35mm
Finish Hole (Mechanical)	0.10mm6.30mm
Diameter Tolerance (Mechanical)	0.05mm
Registration (Mechanical)	0.075mm
Aspect Ratio	16:1
Solder Mask Type	LPI
SMT Mini. Solder Mask Width	0.075mm
Mini. Solder Mask Clearance	0.05mm
Plug Hole Diameter	0.25mm0.60mm
Impedance Control Tolerance	±10%
Surface Finish	HASL, ENIG, Chem. Tin, Flash Gold, OSP, Gold finger

Fast Response Service

Category	Quickest Lead Time	Normal Lead Time
Double sides	<u>24hrs</u>	<u>120hrs</u>
<u>4 layers</u>	<u>48hrs</u>	<u>172hrs</u>
<u>6 layers</u>	<u>72hrs</u>	<u>192hrs</u>
<u>8 layers</u>	<u>96hrs</u>	<u>216hrs</u>
<u>10 layers</u>	<u>120hrs</u>	<u>288hrs</u>
<u>12 layers</u>	<u>144hrs</u>	<u>288hrs</u>
<u>14 layers</u>	<u>168hrs</u>	<u>312hrs</u>
<u>16-20 layers</u>	Depends on the specific requirements	
Above 20 layers	Depends on the specific requirements	

















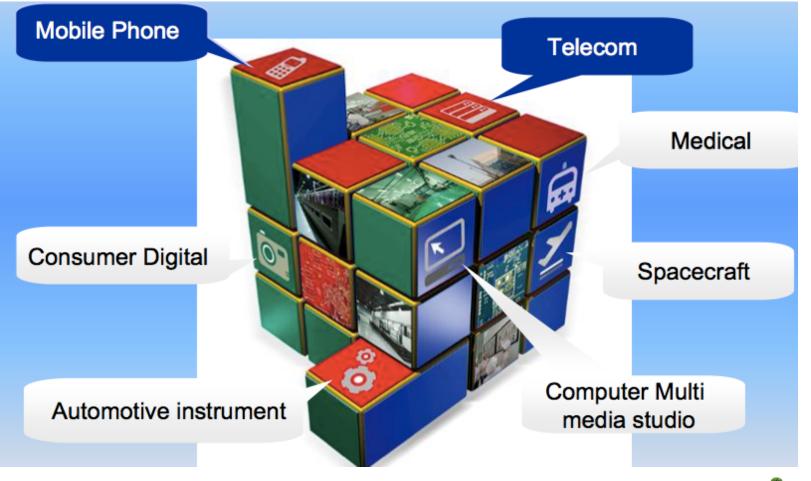




Unit: million dollar



Product Application





Quality System Certification



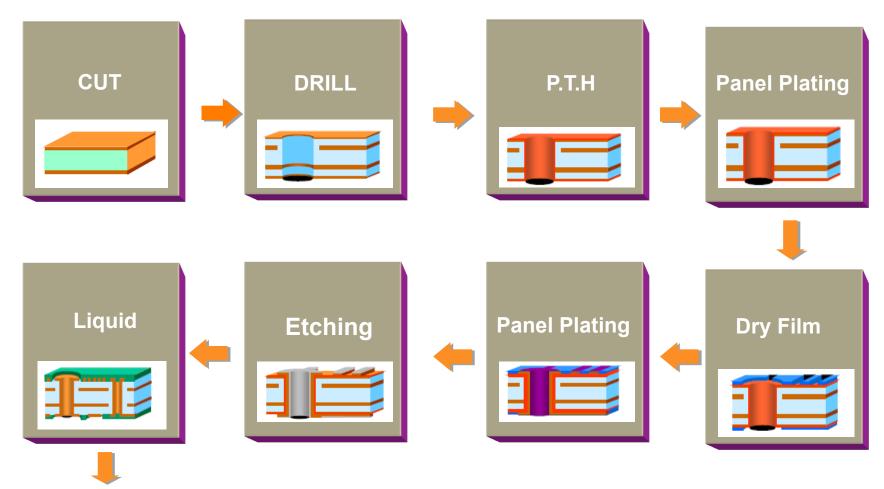


Quality System Certification

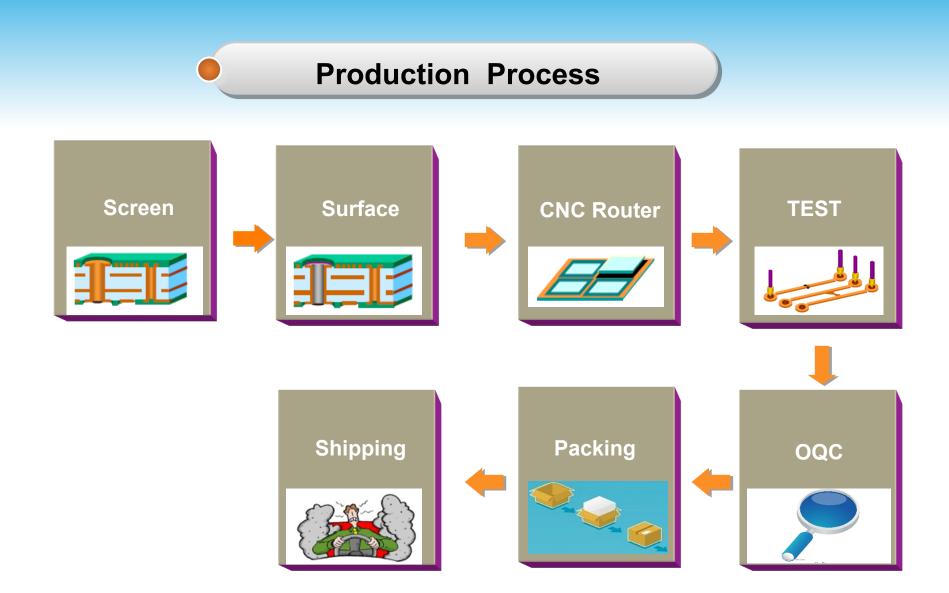
Quality Goal



Production Process









	Configuration	Brand
Laminate	Pressing Machines *1	Tai Wan VIGOR
Drill	Drilling Machine *4	Tai Wan Tong Tai
P.T.H	Auto Line *1	Chang Zhou LIDA
Panel Plating	Auto Line *1	Chang Zhou LIDA
Dry Film	Imagine Machine *1	Tai Wan CSun



	Configuration	Brand
Panel Plating	Auto Line *1	Chang Zhou LIDA
Etching	Auto Line *1	Rong Hua KC
Sold Mask	Printing Machine *2	Tai Wan ATMA
Sold Mask	Imagine Machine *1	Tai Wan CSun
Developing Machine	Auto Line *1	Rong Hua KC



	Configuration	Brand
Cleaning Line	1Auto Line *1	Rong Hua KC
Silk Screen	Printing Machine *3	Tai Wan ATMA
Oven	Oven *4	Tai Wan CSun
CNC Router	Drilling Machine *5	Tai Wan Tong Tai
Tester	O/S Test *3	Tai Wan JIYU



	Configuration	Brand
automatic Scraping tin machine Line	1Auto Line *3	Rong Hua KC
SMT machine	Chip Mounter *6	Panasonic/SONY/JUKI
Reflow Soldering Machine	Reflow Soldering *2	Tai Wan CSun
AOI Detection Machine	DetectionMachine*1	Tai Wan Tong Tai



Production line



Drill



Laminate



Silk Screen



X-Ray



Developing



Production line



Automatic Scraping tin machine





Panasonic Chip Mounter

SONY Chip Mounter



JUKI Chip Mounter



Reflow Soldering Machine



AOI Detection Machine

Reliability Testing Equipment



impedance tester



Ionic contamination tester







Peel Strength tester





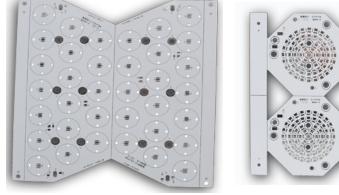
Insulation Resistance Tester

Flying Probe tester













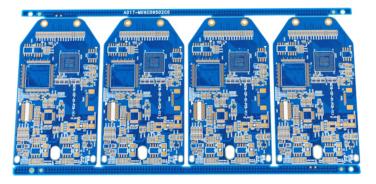
- Material: Aluminum Based (Ventec VT-4A2)
- Board Thickness:1.6 mm
- Copper thickness:1 oz
- Ink: TAIYO INK
- Thermal Conductivity: 2.0W/m*k
- Surface finish: HASL lead free
- Molding:Routing,Punching

- Material: Copper Based
- Board Thickness: 1.6 mm
- Copper Thickness: 2 OZ
- Ink: LB-White INK
- Thermal Conductivity: 3.0W/k.m
- Surface finishing: OSP
- Molding: Routing, Punching



Typical Product 2



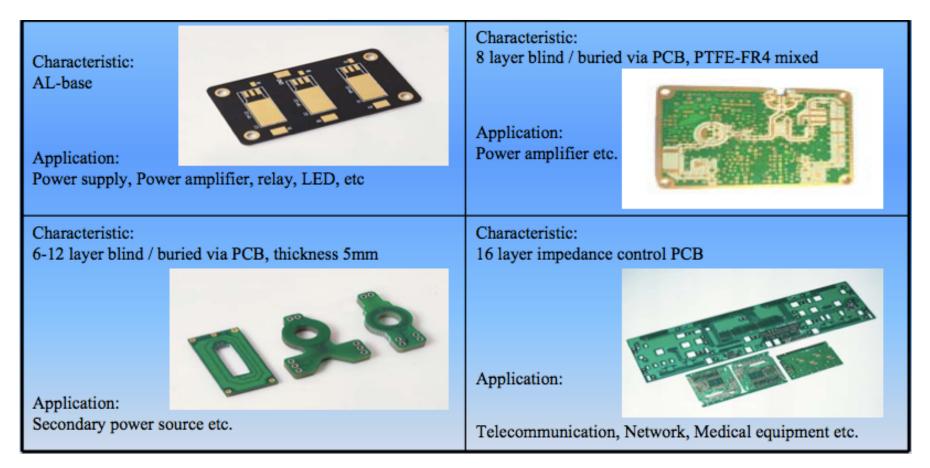


- Material: ShengYi (S1000-2)
- Board Thickness: 1.6 mm+/- 0.1mm
- Copper Thickness: 10Z
- ✤ Layer: 4 Layers
- Solder Impedance Tolerance: +/-8%
- Surface finishing: Immersion Gold
- ✤ Gold Finger Thickness: Min 30 u"

- Material: ShengYi (S1000-2)
- Board Thickness: 1.2 mm+/- 0.1mm
- Copper Thickness: 10Z
- Min Hole Size: 0.25mm
- Min Traces Width:0.075mm
- Surface finishing: Immersion Gold
- Gold Thickness: 1-2 u"



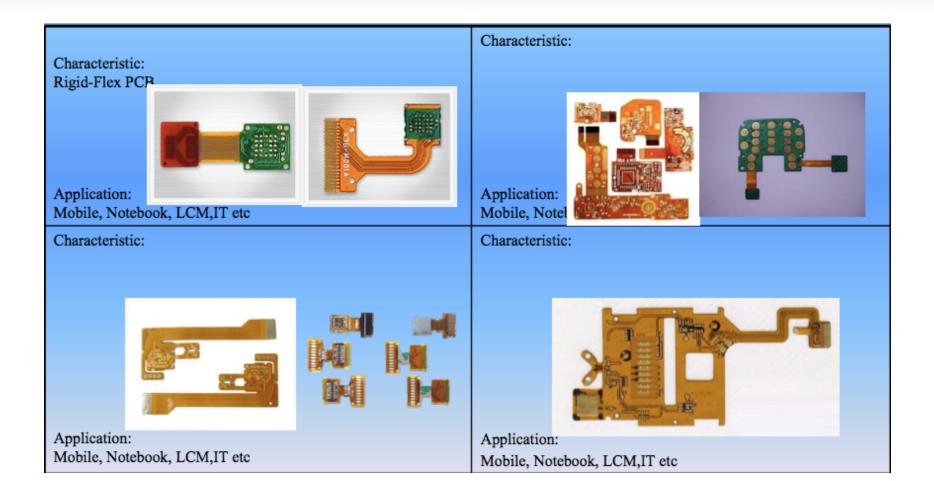
Typical Product 3



Special material product



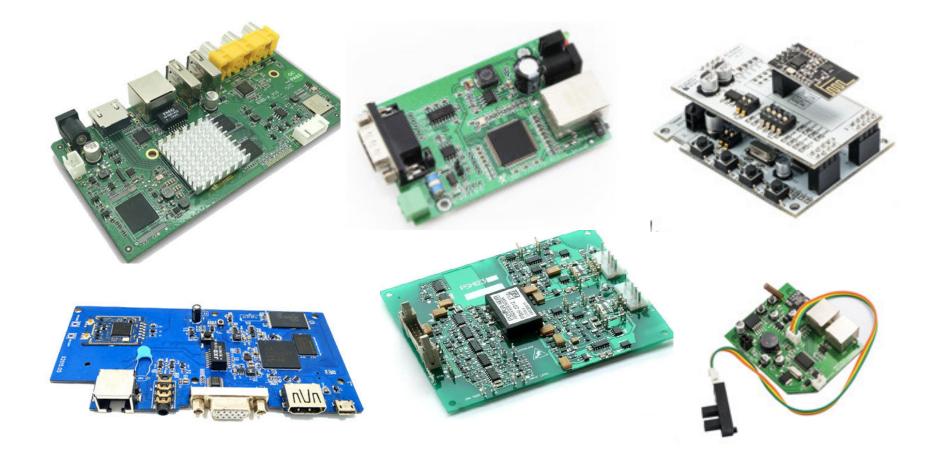




FPC Product







PCBA Product

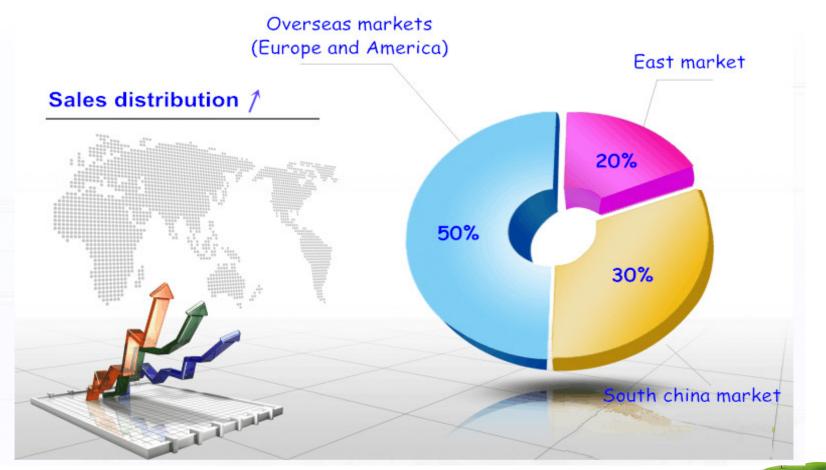




Main Finished Products



Main Market





ENVIRONMENT PROTECTION

"Green" Company:

Our Plant have invested huge money for the waste water and exhaust gas process to reduce the pollutant emission, Through survey and investigation, we decided to adopt environment friendly and energy-efficient technologies and techniques to our plants.

The above mentioned, the application of technologies and techniques as described below indicates that GP indeed assumed its social responsibility of environment protection, by green production and reducing pollution and carbon emission.





OCEAN

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Thank You !